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APPLICATION NO.	FILIN	G DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/720,759	10/720,759 11/25/2003		Hiroaki Matsumura	0055/057001	3107
22893	7590	09/23/2005		EXAMINER	
SMITH PA			NGUYEN, DUNG T		
SUITE 901	YLVANIA.	AVENUE N W		ART UNIT	PAPER NUMBER
WASHINGT	ON, DC 20	0006		2828	

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	
		10/720,759	MATSUMURA, HIROAKI	
	Office Action Summary	Examiner	Art Unit	
		Dung (Michael) T. Nguyen	2828 /	
Period fo	The MAILING DATE of this communication app or Reply	pears on the cover sheet with the c	orrespondence address (-	
A SH WHIC - Exter after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Operiod for reply is specified above, the maximum statutory period were to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim vill apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	I.  lety filed  the mailing date of this communication  (35 U.S.C. § 133).	
Status				
,	Responsive to communication(s) filed on This action is <b>FINAL</b> . 2b)  This Since this application is in condition for allowar closed in accordance with the practice under E	action is non-final. nce except for formal matters, pro		is
Dispositi	ion of Claims			
5) □ 6) ☑ 7) □ 8) □ Applicati 9) □ 10) □	Claim(s) 1-20 is/are pending in the application.  4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed.  Claim(s) 1-20 is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or ion Papers  The specification is objected to by the Examine The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the or Replacement drawing sheet(s) including the correction.	vn from consideration.  r election requirement.  r.  epted or b) □ objected to by the Edrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	37 CFR 1.85(a). ected to. See 37 CFR 1.121	(d).
	The oath or declaration is objected to by the Ex	aminer. Note the attached Office	Action of form P1O-152.	
12)⊠ a)[	Acknowledgment is made of a claim for foreign  All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority documents application from the International Bureau See the attached detailed Office action for a list of	s have been received. s have been received in Application ity documents have been receive I (PCT Rule 17.2(a)).	on No d in this National Stage	
2) 🔲 Notic 3) 🔯 Inforr	e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) r No(s)/Mail Date 11/25/03,03/01/05	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa		

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## DETAILED ACTION

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1, 4, 6, 8, 10-13, 16, 18, and 20 are rejected under 35 U.S.C. 103(a) as being unpatentable over the admitted prior art in view of JP03145178.

With respect to claims 1, 4, 6, 8, 11, 16, and 18, Admitted prior art shows in fig.5-6 a ridge waveguide semiconductor laser diode 10 comprising: an n-type semiconductor layer 12; a p-type semiconductor layer 14 having a ridge 14a forming a waveguide; an active layer 13 disposed between said n-type semiconductor layer and said p-type semiconductor layer; a protective insulating layer 17 partially covering said ridge so as to expose at least a portion of a top face of said ridge; a p-side ohmic electrode 15 in ohmic contact with said portion of said ridge; a p-side pad electrode 19 disposed so as to connect to said p-side ohmic electrode.

Admitted prior art lacks an intermediate layer disposed between the electrodes.

JP03145178 teaches in Fig.1d a single intermediate layer (insulator) 4 disposed between the electrodes 2 and 5.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide Admitted prior art what is taught by JP03145178 in order to electrically insulate the electrodes from each other (abstract).

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With respect to claim 10, Admitted prior art discloses in Fig.6 a second protective insulating layer 18 disposed on a portion of said first protective insulating layer 17.

With respect to claim 12, Admitted prior art discloses a conductive joint material 23 (Fig.6).

With respect to claims 13 and 20, Admitted prior art discloses an InAlGaN semiconductor (para 0004).

Claims 2-3, 5, 7, 14, and 17 are rejected under 35 U.S.C. 103(a) as being unpatentable over the admitted prior art in view of JP03145178 and further in view of Hsu (2004/0108804).

With respect to claims 2-3 and 14, the admitted prior art and JP03145178 disclose all limitations of the claims except for the intermediate layer being a buffer layer including diffusion prevention means and adjusting adhesion.

Hsu teaches the intermediate layer being a buffer layer including diffusion prevention means and adjusting adhesion (para.0088).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide the admitted prior art and JP03145178 what is taught by Hsu in order to provide strong adhesion between two layers and function as a diffusion barrier to prevent alloying between the two layers (para.0088).

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With respect to claims 5, 7, and 17, Hsu discloses the intermediate layer is selected from TiO.

Claims 9 and 19 are rejected under 35 U.S.C. 103(a) as being unpatentable over the admitted prior art in view of JP03145178 and further in view of Ko et al. (5436466). Admitted prior art and JP0145178 disclose all limitations of the claims except for the intermediate layer comprising two layers.

Ko teach in col.2, 1.17-19 the intermediate layer comprising two layers.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide the admitted prior art and JP03145178 what is taught by Ko to alternatively employ the intermediate layer comprising one layer or at least two layers.

Claim 15 is rejected under 35 U.S.C. 103(a) as being unpatentable over the admitted prior art in view of JP03145178 and further in view of Hsu (2004/0108804). Admitted prior art shows in fig.5-6 a ridge waveguide semiconductor laser diode 10 comprising: an n-type semiconductor layer 12; a p-type semiconductor layer 14 having a ridge 14a forming a waveguide; an active layer 13 disposed between said n-type semiconductor layer and said p-type semiconductor layer; a protective insulating layer 17 partially covering said ridge so as to expose at least a portion of a top face of said ridge; a p-side ohmic electrode 15 in ohmic contact with said portion of said ridge; a p-side pad electrode 19 disposed so as to connect to said p-side ohmic electrode.

Admitted prior art lacks an intermediate layer disposed between the electrodes.

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JP03145178 teaches in Fig. 1d a single intermediate layer (insulator) 4 disposed between the electrodes 2 and 5.

However, Admitted prior art and JP0145178 lack the intermediate layer including diffusion prevention means.

Hsu teaches the intermediate layer including diffusion prevention means (para.0088).

It would have been obvious to one having ordinary skill in the art at the time the invention was made to provide the admitted prior art and JP03145178 what is taught by Hsu in order to provide a function as a diffusion barrier to prevent alloying between the two layers (para 0088).

## Communication Information

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dung (Michael) T Nguyen whose telephone number is (571) 272-1949. The examiner can normally be reached on 8:30 - 17:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Min Harvey can be reached on (571) 272-1835. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 306-3329.

JAMES MENEREE

Michael Dung Nguyen